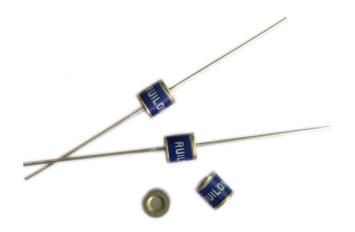
2RA-5 Series

Description

GDT is placed in front of, and in parallel with, sensitive telecom equipment such as power lines, communication lines, signal lines and data transmission lines to help protect them from damage caused by transient surge voltages that may result from lightning strikes and equipment switching operations. These devices do not influence the signal in normal operation. However, in the event of an overvoltage surge, such as a lightning strike, the GDT switches to a low impedance state and diverts the energy away from the sensitive equipment.

Our GDT offer a high level of surge protection, a broad voltage range, low capacitance, and many form factors including new surface mount devices, which makes them suitable for applications such as Main Distribution Frame (MDF) modules, high data-rate telecom applications (e.g. ADSL, VDSL), and surge protection on power lines. Their low capacitance also results in less signal distortion. When used in a coordinated circuit protection solution with PolySwitch devices, they can help equipment manufacturers meet stringent safety regulatory standards.



Electrical symbol



Features

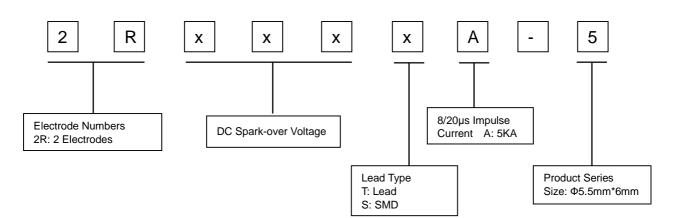
- I Excellent response to fast rising transients
- I Stable breakdown voltage
- I GHz working frequency
- I 8/20µs Impulse current capability: 5KA
- I Non-Radioactive
- I Ultra Low capacitance (<1pF)
- I Lead-free compliant
- I RoHS and REACH compliant
- I UL 497B Recognized: E465335
- I Size: Φ5.5mm*6mm
- I Storage and operational temperature: -40~+90°C

Applications

- I CATV equipment
- I Antennas
- I RS 485
- I Telecom Base Station
- I Power Supply AC Main
- I EV power Charging
- I Inverter/Variable
- Frequency Drivers (VFDs)
- I IEEE 802.3 compliant Ethernet interfaces

- Broad Band equipment
- I xDSL, ADSL, ADSL2, VDSL, and VDSL2
- I Medical Electronics
- I Test Equipment
- I General Telecom Equipment
- I Renewable Energy

Part Number Code



Revised: 2020-03-16





2RA-5 Series

Electrical Characteristics

Part Number		DC Spark-over Voltage ^{1) 2)} @100V/S	Impulse Spark-over Voltage 100V/µS 1KV/µS		Insulation Resistance	Capacitance @1MHz	Life Ratings			
							Impulse Discharge Current @8/20µS		AC Discharge Current @50Hz 1S	Impulse Life @10/1000µS 100A
			DIP	SMD	v	V	٧	GΩ	pF	KA
2R075TA-5	2R075SA-5	75±20%	500	600	1	1	5	10	5	300
2R090TA-5	2R090SA-5	90±20%	500	600	1	1	5	10	5	300
2R150TA-5	2R150SA-5	150±20%	500	600	1	1	5	10	5	300
2R230TA-5	2R230SA-5	230±20%	600	700	1	1	5	10	5	300
2R250TA-5	2R250SA-5	250±20%	600	700	1	1	5	10	5	300
2R300TA-5	2R300SA-5	300±20%	750	850	1	1	5	10	5	300
2R350TA-5	2R350SA-5	350±20%	800	900	1	1	5	10	5	300
2R400TA-5	2R400SA-5	400±20%	850	950	1	1	5	10	5	300
2R420TA-5	2R420SA-5	420±20%	850	950	1	1	5	10	5	300
2R470TA-5	2R470SA-5	470±20%	900	1000	1	1	5	10	5	300
2R600TA-5	2R600SA-5	600±20%	1000	1200	1	1	5	10	5	300
2R800TA-5	2R800SA-5	800±20%	1200	1400	1	1	5	10	5	300
Glow Voltage a	t 10mA				~60V					
Arc Voltage at	1A				~10V					
Glow to Arc trai	nsition Current				~0.5A					
Weight					-0.82g -0.55g					
Operation and storage temperature										
Climatic category (IEC 60068-1)				40/90/2	1					
Marking, blue negative				••••	RUILON XXX Y XXX -Nominal voltage					
						Year of product	•			
Surface treatme	ent					Nickel Plated				
					SMD -	Matte-tin plated	t			

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75V at DC 25V

90V~150V at DC 50V

Other at DC 100V

Terms in accordance with ITU-T Rec. K.12, IEC 61643-311, GB/T 9043.



¹⁾ At delivery AQL 0.65 level II, DIN ISO 2859

²⁾ In ionized mode

³⁾ Insulation Resistance Measuring Voltage:

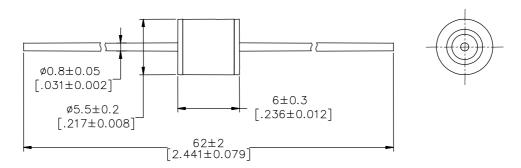


2RA-5 Series

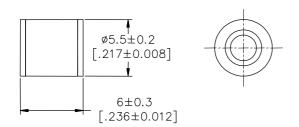
Dimensions

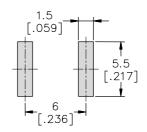
(Unit: mm/inch)

DIP Series (2RxxxTA-5)



SMD Series (2RxxxSA-5)



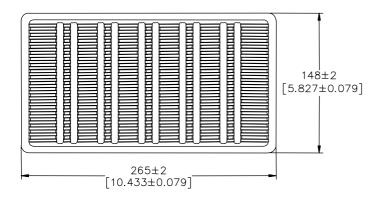


Recommended Soldering Pad Layout

Packaging Information (Unit: mm/inch)

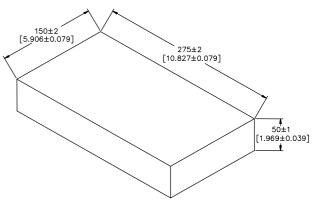
Axial Packaging (Bulk)

Plastic Tray



Inner box

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Packaging Quantity:

100 PCS per Plastic Tray

5 Plastic Trays per inner box

500 PCS per inner box





2RA-5 Series

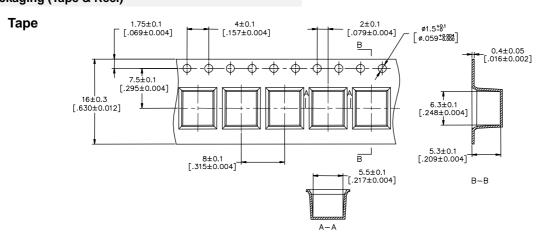
1000 PCS per reel

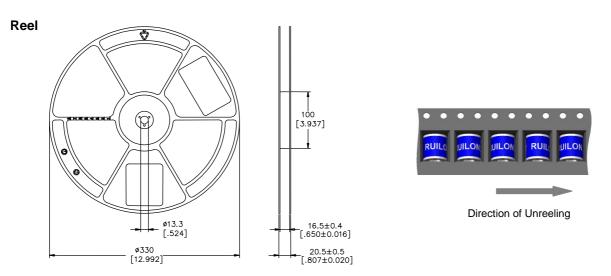
Axial Packaging (Tape & Reel)

Tape Reel 72±2 [2.835±0.079] ___65±2 [2.559±0.079] ø16±1 [ø.63±0.039] ____23.5±1 [.925±0.039] ____23.5±1 [.925±0.039] 10±0.5 [.394±0.020] 1 2Max 82±2 [.047Max.] ø330±2 [12.992±0.079] [3.228±0.079] 1.2Max. [.047Max.] 2.5±0.5 [.098±0.020] **Packaging Quantity:**

SMD Packaging (Tape & Reel)

___6±1 [.236±0.039] 6±0.3 [.236±0.012]

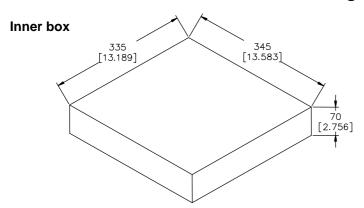




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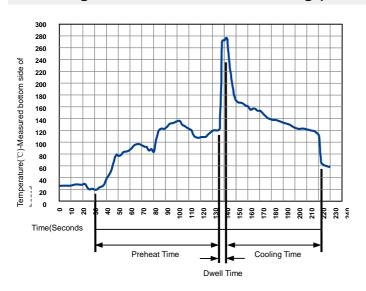
2RA-5 Series



Packaging Quantity:

- 1,000 PCS per reel (13")
- 3 reels per inner box
- 3,000 PCS per inner box

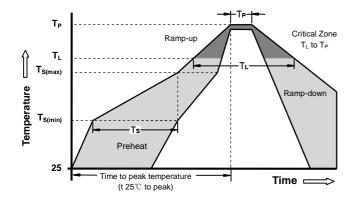
Soldering Parameters - Wave soldering (Thru-Hole Devices)



Wave Solo	lering Condition	Pb-Free assembly		
Preheat	Temperature Min	100°C		
	Temperature Max	150°C		
	Time (Min to Max)	60-180 Seconds		
Solder Pot	Temperature	280°C Max		
Solder Dw	ell Time	2-5 Seconds		

Soldering Parameters - Reflow Soldering (Surface Mount Devices)

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Reflow Co	ndition	Pb - Free assembly			
	-Temperature Min (T _{s(min)})	150°C			
Preheat	-Temperature Max (T _{s(max)})	200°C			
	- Time (min to max) (t _s)	60 -180 Seconds			
Average ra T _L) to peal	amp up rate (Liquids Temp ເ	3°C/second max			
T _{S(max)} to T	L - Ramp-up Rate	5°C/second max			
Reflow	- Temperature (T _L) (Liquids)	217°C			
	- Time (min to max) (t _s)	60 -150 Seconds			
Peak Tem	perature (T _P)	260 +0/-5°C			
Time withi	n 5°C of actual peak ure (t _p)	10 - 30 Seconds			
Ramp-dov	vn Rate	6°C/second max			
Time 25°C	to peak Temperature (T _P)	8 minutes Max			
Do not exc	ceed	260°C			

